

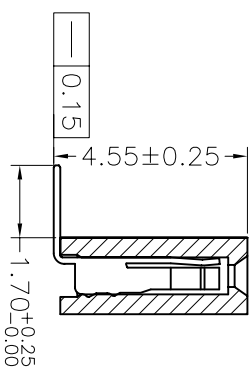
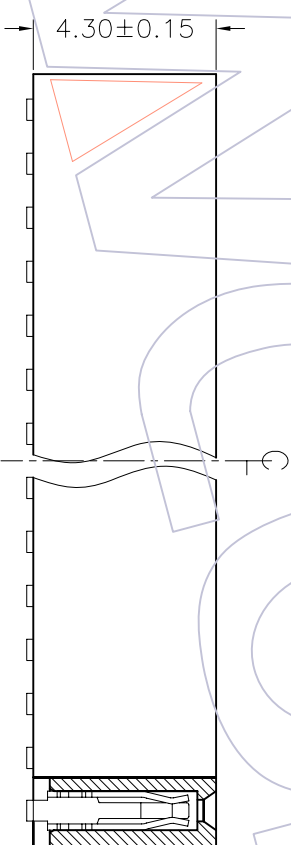
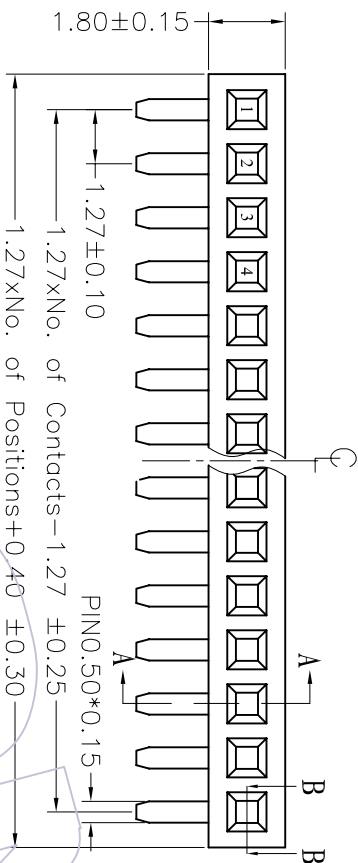
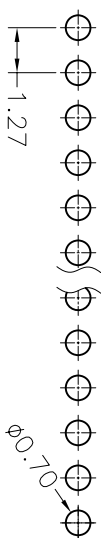
HSP

NOTES:

Current Rating: 1.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G. F UL94V-0

Recommended P.C.B Layout(TOP Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

2344 - 1XX R XX CUNT 1

No. of Pins per Row: 02-50Pin
 Contact Plating: GO=Gold Flash
 GH=3μ"Gold
 GS=5μ"Gold
 G3=10μ"Gold
 GA=15μ"Gold
 GS=30μ"Gold
 SO=Gold Flash/Tin
 SI=3μ"Gold/Tin
 S2=5μ"Gold/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin

Packing: T=Tube

SECTION B-B

SECTION A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	 WCON 维峰五金电子有限公司 WAVE HARDWARE ELECTRONICS CO.,LTD	PART NO.	TITLE:
A0	08/02/16	NEW			X.X X.XX X.XXX	DESIGN CHECK	3:1 mm A4			
1					Angle DIM	APPROVE				

1 2 3 4 5 6 7 8 9 10